

# AO3400

30V N-Channel Enhancement-Mode MOSFET

**VDS = 30V**

**RDS(ON), Vgs@10V, Ids@5.8A < 28mΩ**

**RDS(ON), Vgs@4.5V, Ids@5.0A < 33mΩ**

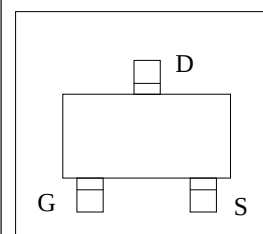
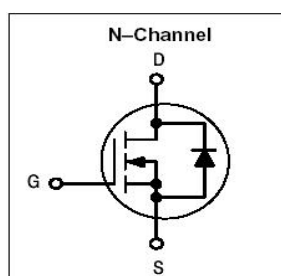
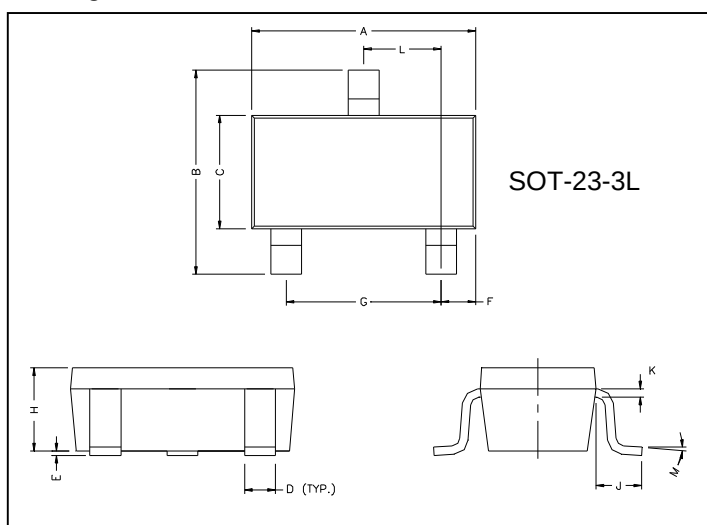
**RDS(ON), Vgs@2.5V, Ids@4.0A < 52mΩ**

## Features

Advanced trench process technology

High Density Cell Design For Ultra Low On-Resistance

## Package Dimensions



| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 2.70       | 3.10 | G    | 1.90       | REF. |
| B    | 2.65       | 2.95 | H    | 1.00       | 1.30 |
| C    | 1.50       | 1.70 | K    | 0.10       | 0.20 |
| D    | 0.35       | 0.50 | J    | 0.40       | -    |
| E    | 0          | 0.10 | L    | 0.85       | 1.15 |
| F    | 0.45       | 0.55 | M    | 0°         | 10°  |

## Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted)

| Parameter                                            | Symbol                            | Limit      | Unit |
|------------------------------------------------------|-----------------------------------|------------|------|
| Drain-Source Voltage                                 | V <sub>DS</sub>                   | 30         | V    |
| Gate-Source Voltage                                  | V <sub>GS</sub>                   | ± 12       |      |
| Continuous Drain Current                             | I <sub>D</sub>                    | 5.8        | A    |
| Pulsed Drain Current                                 | I <sub>DM</sub>                   | 30         |      |
| Maximum Power Dissipation                            | P <sub>D</sub>                    | 1.4        | W    |
|                                                      |                                   | 1          |      |
| Operating Junction and Storage Temperature Range     | T <sub>J</sub> , T <sub>stg</sub> | -55 to 150 | °C   |
| Junction-to-Ambient Thermal Resistance (PCB mounted) | R <sub>θJA</sub>                  | 145        | °C/W |

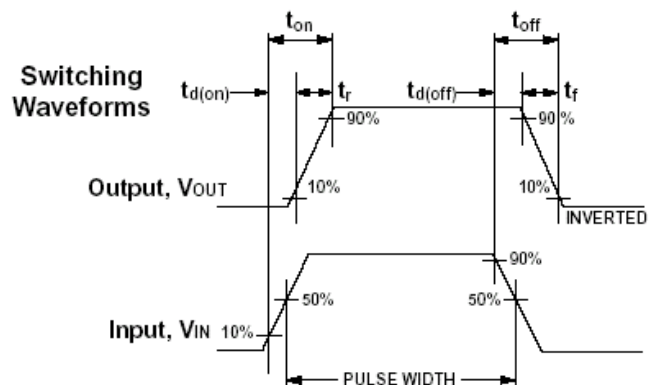
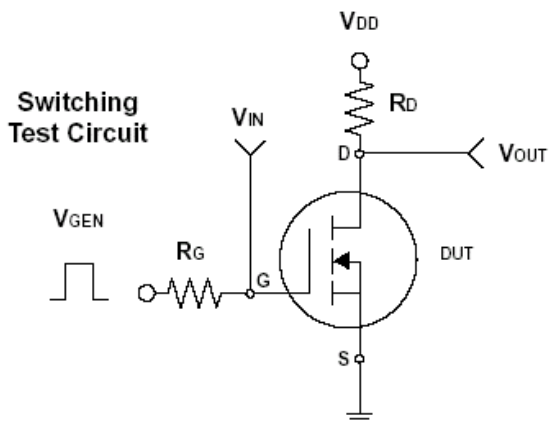
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## ELECTRICAL CHARACTERISTICS (TA = 25oC unless otherwise noted)

| Parameter                        | Symbol              | Test Condition                                                                                                    | Min. | Typ. | Max. | Unit |
|----------------------------------|---------------------|-------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| Static                           |                     |                                                                                                                   |      |      |      |      |
| Drain-Source Breakdown Voltage   | BV <sub>DSS</sub>   | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA                                                                      | 30   |      |      | V    |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> = 10V, I <sub>D</sub> = 5.8A                                                                      |      | 22.0 | 28.0 | mΩ   |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> = 4.5V, I <sub>D</sub> =5A                                                                        |      | 27.0 | 33.0 |      |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> = 2.5V, I <sub>D</sub> =4A                                                                        |      | 43.0 | 52.0 |      |
| Gate Threshold Voltage           | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250uA                                                         | 0.7  |      | 1.4  | V    |
| Zero Gate Voltage Drain Current  | I <sub>DSS</sub>    | V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V                                                                       |      |      | 1    | uA   |
| Gate Body Leakage                | I <sub>GSS</sub>    | V <sub>GS</sub> = ± 12V, V <sub>DS</sub> = 0V                                                                     |      |      | ±100 | nA   |
| Forward Transconductance         | g <sub>fs</sub>     | V <sub>DS</sub> = 5V, I <sub>D</sub> = 5A                                                                         | 10   | 15   | —    | S    |
| Gate Resistance                  | R <sub>g</sub>      | F=1.0MHz                                                                                                          | 6    | 7    | 7.5  | Ω    |
| Dynamic                          |                     |                                                                                                                   |      |      |      |      |
| Total Gate Charge                | Q <sub>g</sub>      | V <sub>DS</sub> = 15V, I <sub>D</sub> = 5.8A<br>V <sub>GS</sub> = 4.5V                                            |      | 11   | 14   | nC   |
| Gate-Source Charge               | Q <sub>gs</sub>     |                                                                                                                   |      | 1.6  |      |      |
| Gate-Drain Charge                | Q <sub>gd</sub>     |                                                                                                                   |      | 2.8  |      |      |
| Turn-On Delay Time               | t <sub>d(on)</sub>  | V <sub>DD</sub> = 15V, R <sub>L</sub> =2.7Ω<br>I <sub>D</sub> = 1A, V <sub>GEN</sub> = 10V<br>R <sub>G</sub> = 3Ω |      | 7    | 11   | ns   |
| Turn-On Rise Time                | t <sub>r</sub>      |                                                                                                                   |      | 15   | 20   |      |
| Turn-Off Delay Time              | t <sub>d(off)</sub> |                                                                                                                   |      | 38   | 50   |      |
| Turn-Off Fall Time               | t <sub>f</sub>      |                                                                                                                   |      | 3    | 10   |      |
| Input Capacitance                | C <sub>iss</sub>    | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V<br>f = 1.0 MHz                                                        |      | 340  |      | pF   |
| Output Capacitance               | C <sub>oss</sub>    |                                                                                                                   |      | 115  |      |      |
| Reverse Transfer Capacitance     | C <sub>rss</sub>    |                                                                                                                   |      | 33   |      |      |
| Source-Drain Diode               |                     |                                                                                                                   |      |      |      |      |
| Max. Diode Forward Current       | I <sub>S</sub>      |                                                                                                                   |      |      | 1.6  | A    |
| Diode Forward Voltage            | V <sub>SD</sub>     | I <sub>S</sub> = 1.6A, V <sub>GS</sub> = 0V                                                                       |      |      | 1.2  | V    |

Note: Pulse test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$



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## Characteristics Curve

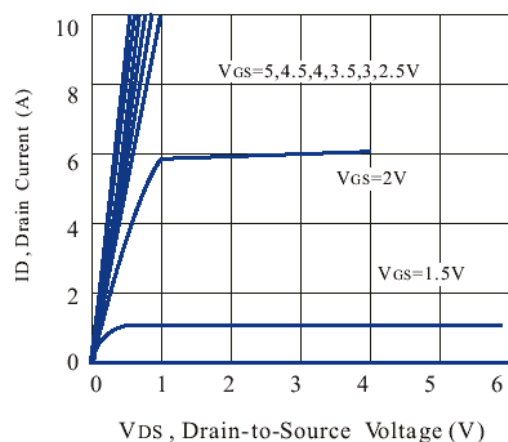


Figure 1. Output Characteristics

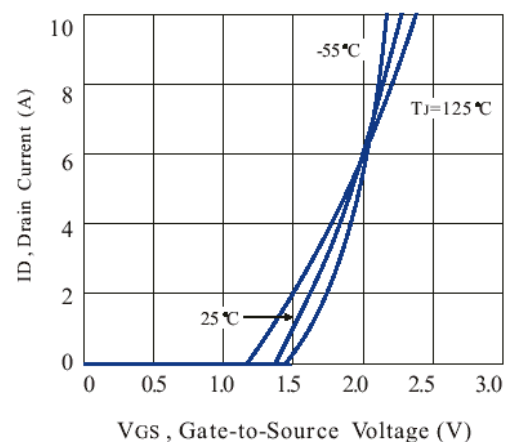


Figure 2. Transfer Characteristics

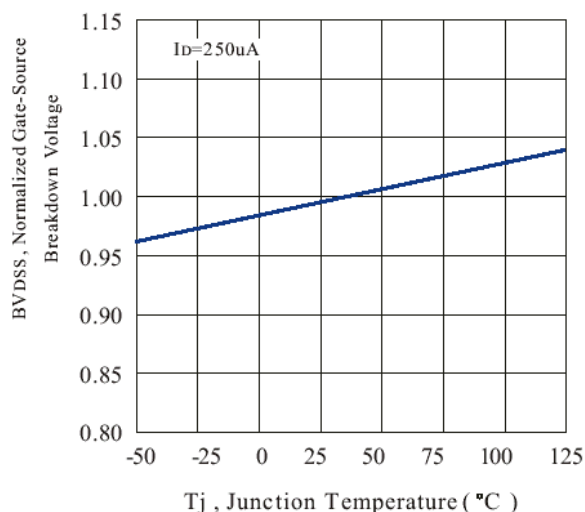


Figure 3. Breakdown Voltage Variation with Temperature

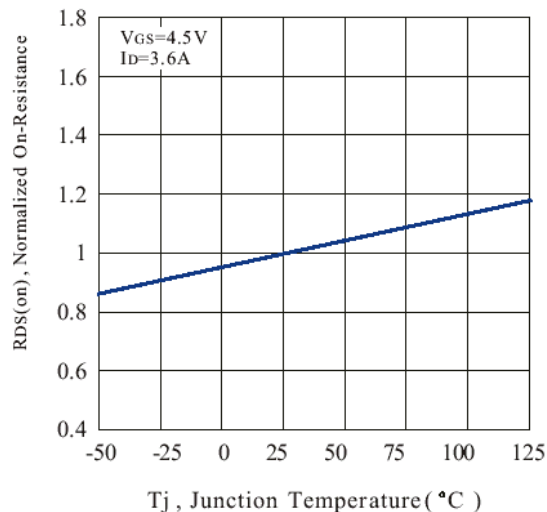


Figure 4. On-Resistance Variation with Temperature

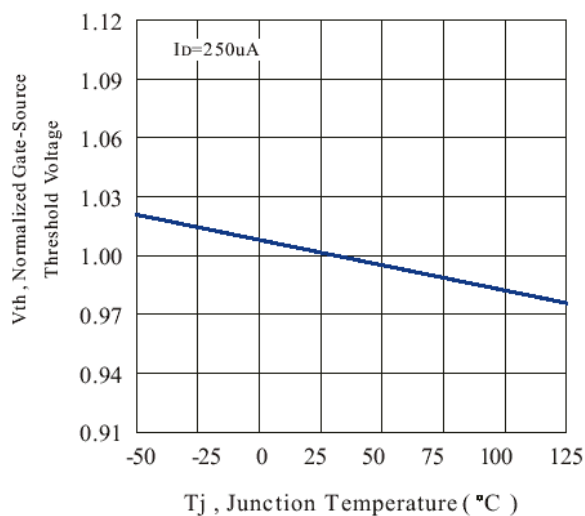


Figure 5. Gate Threshold Variation with Temperature

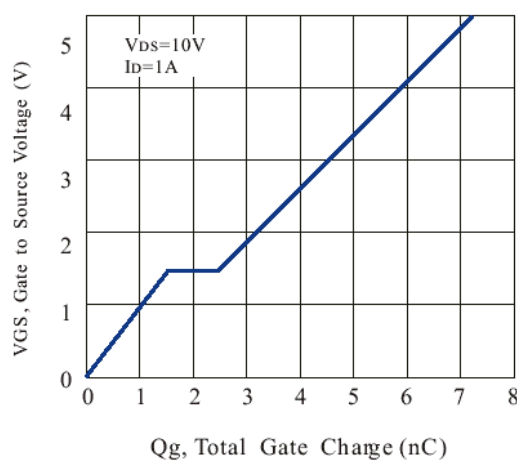


Figure 6. Gate Charge